

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	(oyama fukushima).in. and mounting with electronic.ti. and illuminat\$3 with condition	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/19 09:42
S2	2	mounting with electronic.ti. and (modif\$3 alternat\$3 chang\$3) with (light\$3 illuminat\$3) with condition	USPAT; EPO; JPO	OR	ON	2006/01/19 09:45
S3	207	mounting with (componnent ic chip semiconductor electronic) and (modif\$4 alterat\$3 chang\$3 adjust\$3 regulat\$3) with (light\$3 illuminat\$3) with condition	USPAT; EPO; JPO	OR	ON	2006/01/19 09:48
S4	546	mounting near5 (componnent ic chip semiconductor electronic) and (modif\$4 alterat\$3 chang\$3 adjust\$3 regulat\$3) with (light\$3 illuminat\$3) with (position condition)	USPAT; EPO; JPO	OR	ON	2006/01/19 10:02
S5	19	"29"/\$.ccls. and S4	USPAT; EPO; JPO	OR	ON	2006/01/19 14:11
S6	1	("5072127").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/19 10:24
S7	6	("5739525").URPN.	USPAT	OR	ON	2006/01/19 10:24
S8	303	mounting near5 (componnent ic chip semiconductor electronic) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) near5 (light\$3 illuminat\$3) near4 (position condition intensive pattern)	USPAT; EPO; JPO	OR	ON	2006/01/19 14:05
S9	507	(mount mounted place placing mounting) near5 (componnent ic chip semiconductor electronic) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) near5 (light\$3 illuminat\$3) near4 (position condition intensive pattern) and (print\$3 wiring circuit) near2 (board substrate)	USPAT; EPO; JPO	OR	ON	2006/01/19 14:14
S10	100	(mount mounted place placing mounting) near5 (componnent ic chip semiconductor electronic) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) near5 (light\$3 illuminat\$3) near4 (position condition intensive pattern) and (print\$3 wiring circuit) near2 (board substrate) and image with display	USPAT; EPO; JPO	OR	ON	2006/01/19 14:07
S11	9	"29"/\$.ccls. and S9	USPAT; EPO; JPO	OR	ON	2006/01/19 14:11

S12	41	(mount mounted place placing mounting) near5 (componnent ic chip semiconductor electronic) with (suction nozzle head) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) near5 (light\$3 illuminat\$3) near4 (position condition intensive pattern) and (print\$3 wiring circuit) near2 (board substrate)	USPAT; EPO; JPO	OR	ON	2006/01/19 15:28
S13	92	(mount mounted place placing mounting) with (componnent ic chip semiconductor electronic) with (print\$3 wiring circuit) near2 (board substrate) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) near5 (light\$3 illuminat\$3) near4 (position condition intensive pattern) and (recognition recogniz\$3)	USPAT; EPO; JPO	OR	ON	2006/01/19 15:40
S14	8	("4367463" "4972307" "5130531" "5162844" "5710671" "5784656" "6386669" "6400099").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/19 15:32
S15	10	(mount mounted place placing mounting) with (componnent ic chip semiconductor electronic) with (print\$3 wiring circuit) near2 (board substrate) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable) with (light\$3 illuminat\$3) with (position condition intensive pattern) and (recognition recogniz\$3) and (ccd camera) and (display\$3 monitor) and (nozzle head) with (suck\$3 suction vacuum)	USPAT; EPO; JPO	OR	ON	2006/01/20 11:21
S16	23	(mount mounted place placing mounting) with (componnent ic chip semiconductor electronic) with (print\$3 wiring circuit) near2 (board substrate) and (modif\$4 alter\$3 alterat\$3 chang\$3 adjust\$3 regulat\$3 move moving movable switch\$3) with (light\$3 illuminat\$3 illuminescence) with (position condition intensive pattern) and (recognition recogniz\$3) and (ccd camera) and (nozzle head) with (suck\$3 suction vacuum)	USPAT; EPO; JPO	OR	ON	2006/01/20 11:35

S17	10	("20010016063" "4893223" "5058178" "5093554" "5519809" "5569912" "6043877" "6122042" "6167715" "6256091").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/20 11:38
S18	8	("4367463" "4972307" "5130531" "5162844" "5710671" "5784656" "6386669" "6400099").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/20 15:41